

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TOBIAS ERLBACHER	09/19/2019
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Property Type	Number
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DATE SIGNED:	09/27/2019
Total Attachments: 1	
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Assignment

In Consideration of the sum of One Euro (€1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Fraunhofer-Gesellschaft zur Foerderung der angewandten Forschung e.V., a corporation organized under the laws of Germany, and having its principal office and place of business at Hansastr. 27c, 80686 Muenchen, Germany, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sold, assigned, transferred and set over unto the said assignee the entire right, title and interest in and to the invention or improvement in

Method For Producing Semiconductor Capacitors Having Different

Capacitance Values In A Semiconductor Substrate

said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, which claims priority of German patent application number 10 2018 217 001.0 filed October 4, 2018, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries of its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title of said invention or any Letters Patents which may be granted therefor in said Assignee, its successors, assigns or other legal representatives, and upon the request and at the expense of said assignee, will execute any additional, continuation, or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of said Letters Patents to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner of Patents is Hereby Authorized and Requested to issue any and all Letters Patents of the United States for said invention to said assignee.

Signed and sealed this 19 day of September, 2019.

Witness: Katharina Weisel

K Weisel

Tobias Erlbacher

Attorney Docket No: FGF.P0060